PTC thermistors as heating elements

Rectangular, 12 V

Series/Type: **R41**
Ordering code: **B59041***
Date: 2024-11-20

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Applications



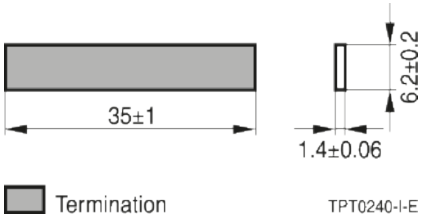
Automotive applications

- Diesel fuel preheating
- Defrosting
- Additional cabin heating

Features

- Silver metallization
- For clamp contacting, not suitable for soldering
- Self-regulating
- RoHS-compatible

Dimensional drawings in mm



General technical data

Max. operating voltage		V_{max}	24	V DC
Rated voltage		V_R	12	V DC
Breakdown voltage		V_{BD}	> 40	V
Curvature			< 0.05	mm
Operating temperature range	(V = 0)	T_{op}	-40/+200	°C
Operating temperature range	($V = V_R$)	T_{op}	-40/+100	°C
Tolerance of R_R		ΔR_R	±50	%

Options

Other dimensions and ratings on request.

Delivery mode

Packed in cardboard boxes

2024-11-20

Electrical specifications and ordering codes

T_{ref} (typ.) °C	R_{min} ($V = V_R$) Ω	T_{surf} [1] ($V = V_R$) °C	R_R ($V_{meas} \leq 1.5$ V) Ω	Ordering code
80	1.00	105	3.2	B59041R0080A010
120	1.00	145	3.2	B59041R0120A010
160	0.75	180	3.2	B59041R0160A010
180	0.75	200	3.2	B59041R0180A010
220	1.00	230	6.4	B59041R0220A010

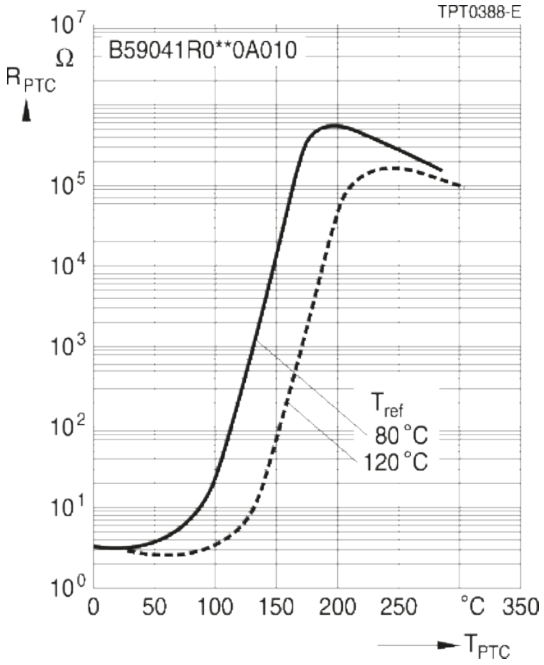
[1] Measured between points

Reliability data

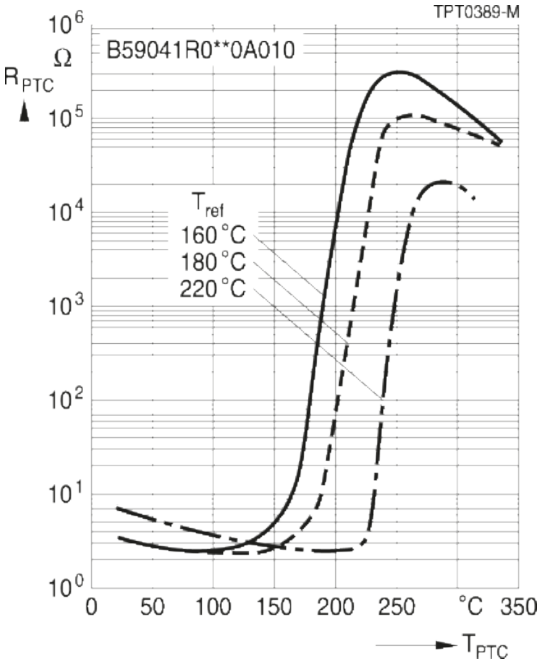
Test	Standard	Test conditions	$\lvert\Delta R_{25}/R_{25}\rvert$
Electrical endurance, cycling	IEC 60738-1	Room temperature, V_{max} Number of cycles: 10 000	< 25%
Electrical endurance, constant	IEC 60738-1	Storage at V_{max} and $T_{op,max}$ (@ V_R) Test duration: 1000 h	< 25%
Damp heat	IEC 60738-1	Temperature of air: 40 °C Relative humidity of air: 93% Duration: 56 days Test according to IEC 60068-2-78	< 25%

Characteristics (typical)

PTC resistance R_{PTC}
versus PTC temperature T_{PTC}
(measured at low signal voltage)



PTC resistance R_{PTC}
versus PTC temperature T_{PTC}
(measured at low signal voltage)



Cautions and warnings

General

- TDK Electronics thermistors are designed for specific applications and should not be used for purposes not identified in our specifications, application notes and data books unless otherwise agreed with TDK Electronics during the design-in-phase.
- Ensure the suitability of the thermistors through reliability testing during the design-in phase. The thermistors should be evaluated taking into consideration worst-case conditions.

Storage

- Store the thermistors only in original packaging. Do not open the package prior to processing.
- Storage conditions in original packaging: storage temperature -25°C to +45°C, relative humidity < 75% annual mean, maximum 95%, dew precipitation is inadmissible.
- Avoid contamination of the surface of the thermistors during storage, handling, and processing.
- Avoid storing thermistors in a harmful environment, as this will otherwise affect their function in long-term operation (examples given under *Operation*).
- Use thermistor within the following period after delivery:
  - Through-hole devices (housed and leaded PTCs): 24 months
  - Motor protection sensors, glass-encapsulated sensors and probe assemblies: 24 months
  - Telecom pair and quattro protectors (TPP, TQP): 24 months
  - Leadless PTC thermistors for pressure contacting: 12 months
  - Leadless PTC thermistors for soldering: 6 months
  - SMDs in EIA sizes 3225 and 4032, and for PTCs with metal tags: 24 months
  - SMDs in EIA sizes 1210 and smaller: 12 months

Handling

- PTCs must not be dropped. Chip-offs must not be caused during handling of PTCs.
- The ceramic and metallization of the components must not be touched with bare hands. Suitable gloves are recommended.
- Avoid contamination of the thermistor surface during handling.

Soldering

- Use rosin-type flux or non-activated flux.
- Insufficient preheating may cause ceramic cracks.
- Rapid cooling by dipping in solvent is not recommended.
- Compete removal of flux is recommended.
- Standard PTC heaters are not suitable for soldering.

Mounting

- The electrode must not be scratched before/during/after the mounting process.
- Contacts and housing used for the assembly with the thermistor have to be clean before mounting. Especially grease or oil must be removed.
- When PTC thermistors are encapsulated with sealing material, the precautions given in the respective datasheet (chapters *Mounting instructions* and *Sealing and potting*) must be observed.
- When the thermistor is mounted, there must not be any foreign body between the electrode of the thermistor and the clamping contact.
- The minimum pressure of the clamping contacts pressing against the PTC must be 50 kPa. In case the assembly is exposed to mechanical shock and/or vibration this force should be higher in order to avoid movement of the PTC during operation.
- During operation, the surface temperature of the thermistor can be very high. Ensure that adjacent components are placed at sufficient distance from the thermistor to allow for proper cooling at the thermistors.
- Ensure that any adjacent materials are designed to operate at a temperature comparable to the surface temperature of the thermistor. Ensure that surrounding parts and materials can withstand this temperature.
- Avoid contamination of thermistor surface during processing.

Operation

- Use thermistors only within the specified temperature operating range.
- Use thermistors only within the specified voltage and current ranges.
- Environmental conditions must not harm the thermistors. Use thermistors only under normal atmospheric conditions. Avoid use in deoxidizing gases (chlorine gas, hydrogen sulfide gas, ammonia gas, sulfuric acid gas etc.), corrosive agents, humid or salty conditions. Contact with any liquids and solvents should be avoided.
- For products with silver electrode: Prevent exposure to electrolytes such as water and moisture to reduce the risk of silver migration. Be sure to provide an appropriate fail-safe function to prevent secondary product damage caused by abnormal function (e.g., use VDR for limitation of overvoltage condition).

This listing does not claim to be complete, but merely reflects the experience of TDK Electronics.

Display of ordering codes for TDK Electronics products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications, on the company website, or in order-related documents such as shipping notes, order confirmations and product labels. **The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products**. Detailed information can be found on the Internet at www.tdk-electronics.tdk.com/orderingcodes.

Symbols and terms

Symbol	Term
A	Area
C	Capacitance
C_{th}	Heat capacity
f	Frequency
I	Current
I_{max}	Maximum current
I_R	Rated current
I_{res}	Residual current
I_{PTC}	PTC current
I_r	Residual current
$I_{r,oil}$	Residual current in oil (for level sensors)
$I_{r,air}$	Residual current in air (for level sensors)
I_{RMS}	Root-mean-square value of current
I_S	Switching current
I_{Smax}	Maximum switching current
LCT	Lower category temperature
N	Number (integer)
N_c	Operating cycles at V_{max}, charging of capacitor
N_f	Switching cycles at V_{max}, failure mode
P	Power
P_{25}	Maximum power at 25 °C
P_{el}	Electrical power
P_{diss}	Dissipation power
R_G	Generator internal resistance
R_{min}	Minimum resistance
R_R	Rated resistance @ rated temperature T_R
ΔR_R	Tolerance of R_R
R_P	Parallel resistance
R_{PTC}	PTC resistance
R_{ref}	Reference resistance
R_S	Series resistance
R_{25}	Resistance at 25 °C
$R_{25,match}$	Resistance matching per reel/ packing unit at 25 °C
ΔR_{25}	Tolerance of R_{25}

T	Temperature
t	Time
T_A	Ambient temperature
t_a	Thermal threshold time
T_C	Ferroelectric Curie temperature
t_E	Settling time (for level sensors)
T_R	Rated temperature @ 25 °C or otherwise specified in the data sheet
T_{sense}	Sensing temperature
T_{op}	Operating temperature
T_{PTC}	PTC temperature
t_R	Response time
T_{ref}	Reference temperature
T_{Rmin}	Temperature at minimum resistance
t_S	Switching time
T_{surf}	Surface temperature
UCT	Upper category temperature
V or V_{el}	Voltage (with subscript only for distinction from volume)
$V_{c(max)}$	Maximum DC charge voltage of the surge generator
$V_{F,max}$	Maximum voltage applied at fault conditions in protection mode
V_{RMS}	Root-mean-square value of voltage
V_{BD}	Breakdown voltage
V_{ins}	Insulation test voltage
$V_{link,max}$	Maximum link voltage
V_{max}	Maximum operating voltage
$V_{max,dyn}$	Maximum dynamic (short-time) operating voltage
V_{meas}	Measuring voltage
$V_{meas,max}$	Maximum measuring voltage
V_R	Rated voltage
V_{PTC}	Voltage drop across a PTC thermistor
α	Temperature coefficient
Δ	Tolerance, change
δ_{th}	Dissipation factor
τ_{th}	Thermal cooling time constant
λ	Failure rate
e	Lead spacing (in mm)

Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application.** As a rule we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified.** In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
4. In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet (www.tdk-electronics.tdk.com/material). Should you have any more detailed questions, please contact our sales offices.
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   We also **reserve the right to discontinue production and delivery of products**. Consequently, we cannot guarantee that all products named in this publication will always be available. The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.
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Important notes

8. The trade names EPCOS, CarXield, CeraCharge, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CTVS, DeltaCap, DigiSiMic, FilterCap, FormFit, InsuGate, LeaXield, MediPlas, MiniBlue, MiniCell, MKD, MKK, ModCap, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PiezoBrush, PlasmaBrush, PowerHap, PQSine, PQvar, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, SurfIND, ThermoFuse, WindCap, XieldCap are **trademarks registered or pending** in Europe and in other countries. Further information will be found on the Internet at www.tdk-electronics.tdk.com/trademarks.

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